



ZPKX2.E493914

Wiring, Printed - Flexible Material Constructions - Component

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Wiring, Printed - Flexible Material Constructions - Component

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REAL TIME FOCUS TECHNOLOGY CORP

E493914

33 JINGJIAN 3RD RD
GUANYIN HSIANG
TAOYUAN HSIEN, 328 TAIWAN

	Cond Width		Cond	SS/ DS/	Max Area	Solder		Max Oper	Meets	C	
	Min	Edge				Limits	Temp				
Type	mm(in)	mm(in)	Thk mic(mil)	DSO	Diam mm(in)	C	sec	C	Flame Class	UL796 DSR	T
Single layer Flexible Materials Interconnect Constructions with Flammability Classification Only.											
FPC-01	-	-	-	DS	-	280	10	-	V-0	-	-

Marking: Company name or tradename "RTF" or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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File E493914
Project 4788065422

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REPORT

On

COMPONENT - Wiring, Printed

REAL TIME FOCUS TECHNOLOGY CORP.,
Taoyuan City 328, Taiwan

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TABLE Ia - PARAMETER PROFILE INDICES

Type	Pattern Limits			Solder Limits		Maximum Operating Temp. (°C)	UL 94 Flamm. Class.
	(A) Min. Width (mm)	(B) Max. Area Diameter (mm)	(C) Min. Edge Width (mm)	Temp. (°C)	Dwell Time (sec.)		
FPC-01	%%	%%	%%	280	10	%%	V-0

TABLE LEGEND:

%% - Not established for Flammability Classification Only Types.

TABLE Ib - SILVER CONDUCTOR LIMITATIONS

Type	Silver Conductors Present (Yes) or (No)	Minimum Spacing Between Adjacent Silver Conductors Of Different Potential (mm)	Maximum Voltage Withstood Between Silver Conductors (V dc)
FPC-01	No	Not Determined	Not Determined

Note: Reference to silver conductors infers silver conductors and silver plated conductors, for purposes of this report, unless otherwise indicated.

BASE MATERIALS

TABLE IIa - BASE MATERIALS (FILM WITH INTEGRAL ADHESIVE)

Type	## Film					Adhesive				Copper		\$ SS/DS	Mfg Process
	+ Mfr	Grade	Generic type	Min Thk (mic)	Max Thk (mic)	+ Mfr	Grade	Min Thk (mic)	Max Thk (mic)	Min Thk (mic)	Max Thk (mic)		
										%%	%%		
Not applicable, reserved for future use.													

TABLE LEGEND:

- ## - Recognized Component - Plastic (QMFZ2); film received without integral adhesive or clad-conductor.
- + - Manufacturers Name (UL File #) -
- \$ - SS: Single-Sided (Only); DS: Double-Sided or Single-Sided
- %% - Not established for Flammability Classification Only Types.

GRADE DESIGNATIONS FOOTNOTES:

TABLE IIb - BASE MATERIALS (FILM WITH INDEPENDENT ADHESIVE AND COPPER)

Type	## Film					Adhesive				Copper		\$ SS/DS	Mfg Process
	+ Mfr	Grade	Generic type	Min Thk (mic)	Max Thk (mic)	+ Mfr	Grade	Min Thk (mic)	Max Thk (mic)	Min Thk (mic)	Max Thk (mic)		
										%%	%%		
Not applicable, reserved for future use.													

TABLE LEGEND:

- ## - Recognized Component - Plastic (QMFZ2); film received without integral adhesive or clad-conductor.
- + - Manufacturers Name (UL File #) -
- \$ - SS: Single-Sided (Only); DS: Double-Sided or Single-Sided
- %% - Not established for Flammability Classification Only Types.

GRADE DESIGNATIONS FOOTNOTES:

BASE MATERIALS - continued

TABLE IIc - BASE MATERIALS (ADHESIVELESS - INTEGRAL FILM/COPPER)

Type	# Base Material								Mfg Process
	+ Mfr	Grade Designation	Film			\$ SS/DS	Copper Thickness		
			Generic Type	Min Thk (mic)	Max Thk (mic)		Min (mic)	Max (mic)	
FPC-01	TA	2FP-F	PI	25	50	DS	%%	%%	A
	TH	Thinflex-A	PI	25	50	DS	%%	%%	A

TABLE LEGEND:

- # - Recognized Component - Industrial Laminates (QMTS2); received as integral film/adhesive/copper systems, unless otherwise indicated.
- + - TA: TAIFLEX (E193078); THINFLEX (E219724)
- \$ - SS: Single-Sided (Only); DS: Double-Sided or Single-Sided
- %% - Not established for Flammability Classification Only Types.

GRADE DESIGNATIONS FOOTNOTES:

COVER LAYER

TABLE IIIa - COVER FILM (FILM WITH INTEGRAL ADHESIVE ON ONE SIDE)

Type	Cover Film #						To Be Used With		Mfg Process	
	+ Mfr	Grade	Film			Adhesive		Base Material		
			Generic Type	Min Thk (mic)	Max Thk (mic)	Min Thk (mic)	Max Thk (mic)	+ Mfr		Grade
FPC-01	TA	FHT	PI	25	50	15	25	See Table IIc	A	
	TH	Thinflex-Q	PI	25	25	12.5	25	See Table IIc	A	

TABLE LEGEND:

- # - Recognized Component - Industrial Laminates (QMTS2); received as integral film/adhesive system.
- + - TA: TAIFLEX (E193078); THINFLEX (E219724)
- \$ - SS: Single-Sided (Only); DS: Double-Sided or Single-Sided

GRADE DESIGNATIONS FOOTNOTES:

TABLE IIIb - COVER FILM (FILM WITH INDEPENDENT ADHESIVE)

Type	Film ##					Adhesive				To Be Used With Base Material		Mfg Process
	+ Mfr	Grade	Generic Type	Thickness		+ Mfr	Grade	Thickness		+ Mfr	Grade	
				Min (mic)	Max (mic)			Min (mic)	Max (mic)			
Not applicable, reserved for future use.												

TABLE LEGEND:

- ## - Recognized Component - Plastic (QMFZ2); film received without integral adhesive.
- + - Manufacturers Name (UL File #) -
- \$ - SS: Single-Sided (Only); DS: Double-Sided or Single-Sided

GRADE DESIGNATIONS FOOTNOTES:

COVER LAYER - continued

TABLE IIIc - COVER COAT (COATING FOR USE ON FLEXIBLE BASE MATERIAL)

Type	Cover Coat				To Be Used With Base Material		To Be Used With Cover Film		Mfg Process
	+ Mfr	Grade	Thickness		+ Mfr	Grade	+ Mfr	Grade	
			Min (mic)	Max (mic)					
Not applicable, reserved for future use.									

TABLE LEGEND:

- + - Manufacturers Name (UL File #) -
- \$ - SS: Single-Sided (Only); DS: Double-Sided or Single-Sided

GRADE DESIGNATIONS FOOTNOTES:

TABLE IV - STIFFENER AND STIFFENER ADHESIVE MATERIALS

Type	Adhesive				Stiffener				To Be Used With Base Material		To Be Used With Cover Layer		Mfg Process
	+ Mfr	Grade	Min Thk (mm)	Max Thk (mm)	+ Mfr	Grade	Min Thk (mic)	Max Thk (mic)	+ Mfr	Grade	+ Mfr	Grade	
FPC-01	System Component Symbol and Size Class Number Required.											A	

TABLE LEGEND:

+ - Manufacturers Name (UL File #) -

GRADE DESIGNATIONS FOOTNOTES:

TABLE V - EMI SHIELDING MATERIALS ON FLEX MATERIALS

Type	EMI Shielding Material								To Be Used With Base Material		To Be Used With Cover Layer		Mfg Process
	Type	+ Mfr	Grade	\$ SS/ DS	Film		Adhesive		+ Mfr	Grade	+ Mfr	Grade	
					Min Thk (mic)	Max Thk (mic)	Min Thk (mic)	Max Thk (mic)					
Not applicable, reserved for future use.													

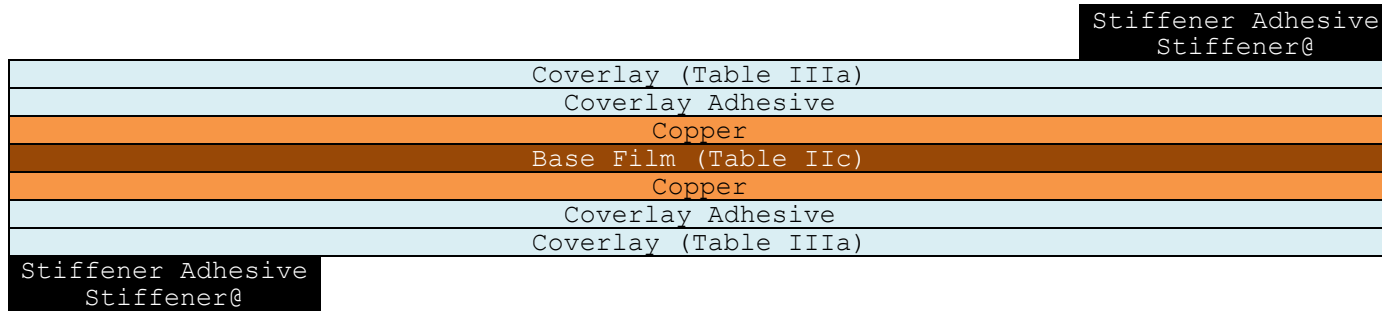
TABLE LEGEND:

+ -

\$ - SS: Single-Sided (Only); DS: Double-Sided or Single-Sided (See FIGURES for detail EMI Shielding Film Applicable Constructions.)

GRADE DESIGNATIONS FOOTNOTES:

Figure 1 - Type FPC-01



Notes:	
@	SCS/SCN MUST be used when Stiffener/Stiffener Adhesive used in construction
1	For type FPC-01, the coverlay MUST be entirely cover the board surface except PTH and contact finger area.

